
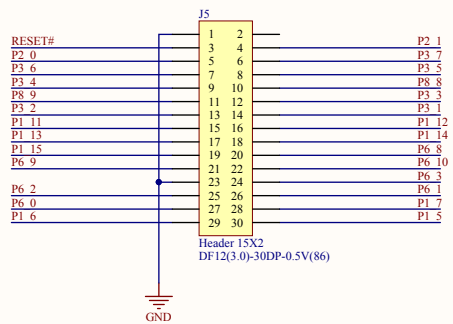
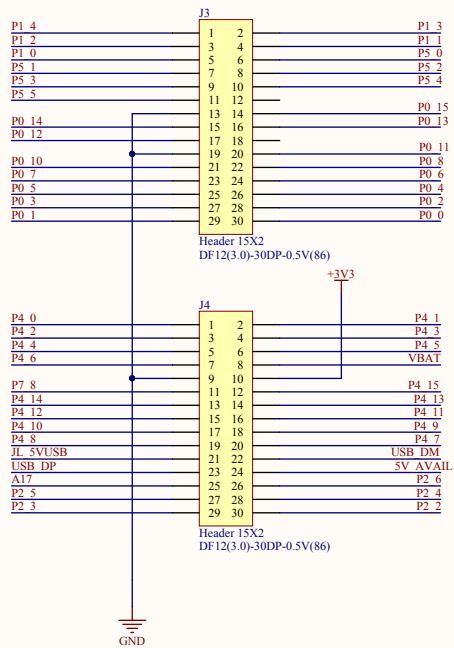
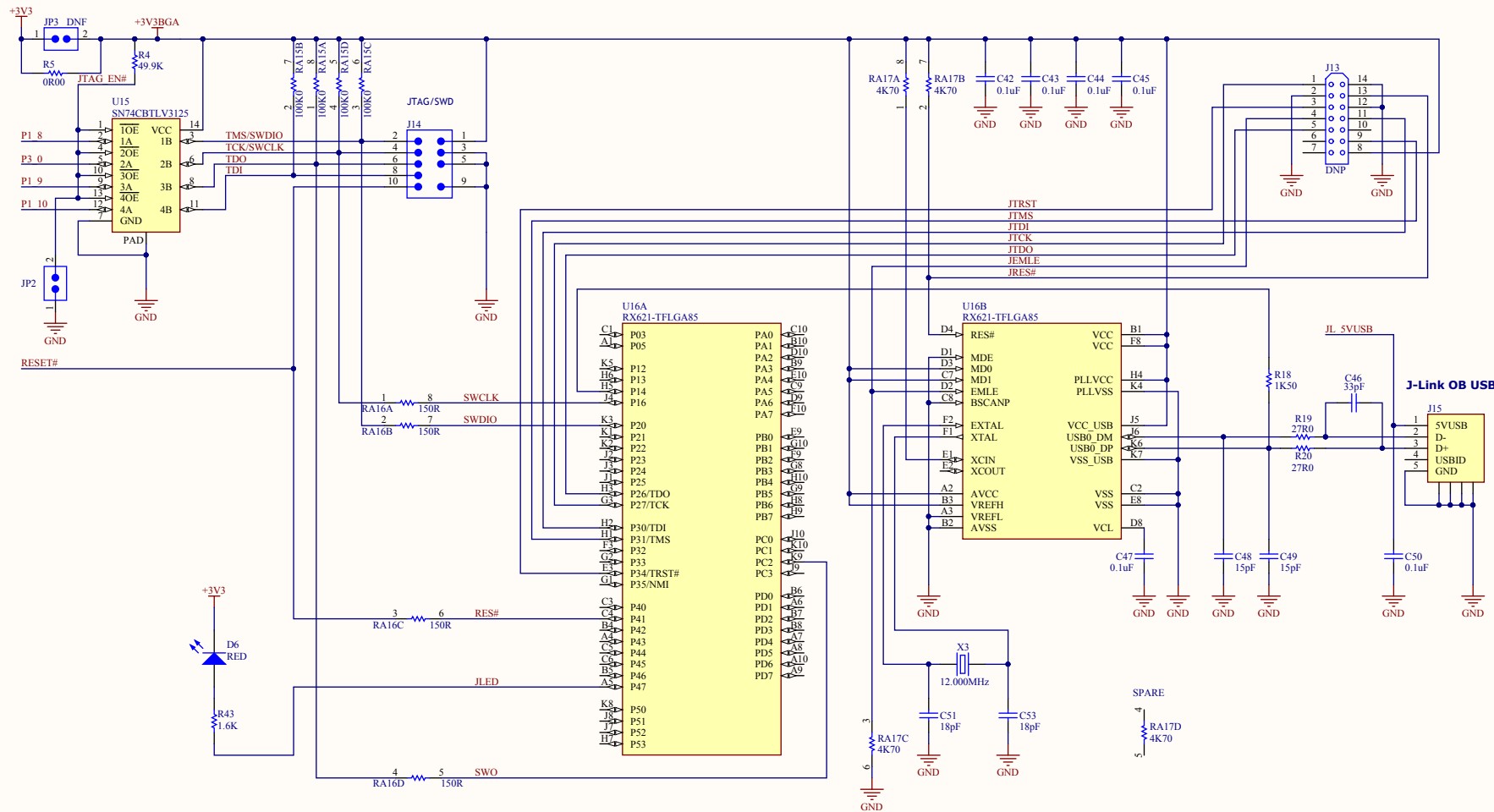


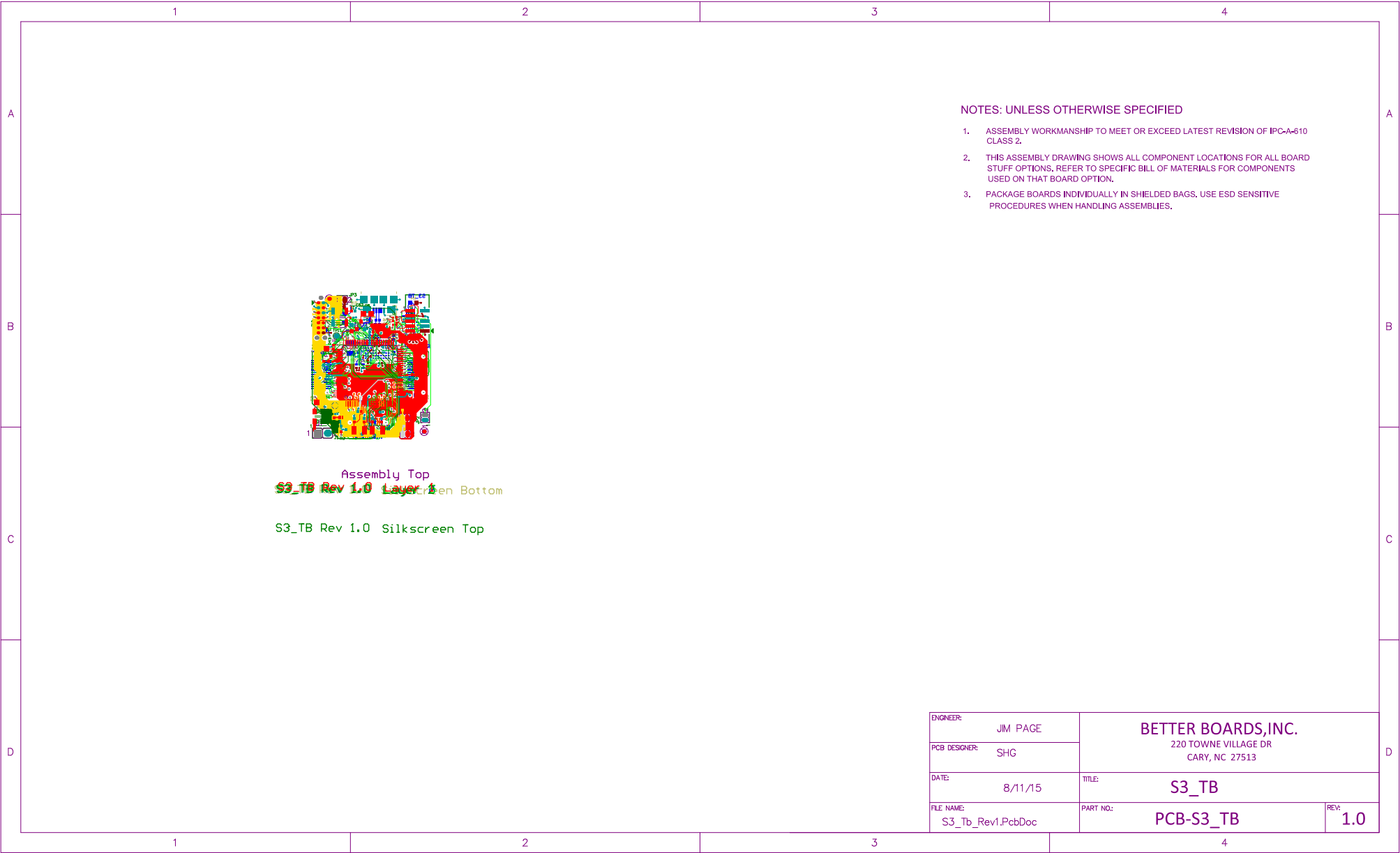
Power Supplies

Title <b>Renesas</b>			
Size: <b>B</b>	Number: <b>1</b>	Revision: <b>02</b>	
Date: 9/10/2015	Time: 4:23:34 PM	Sheet 1 of 5	
File: C:\Users\page01\Desktop\S3_TB_BB(8-19-2015 4-29-06 PM)\S3_TB_BB\S3_TB_BB\S3_TB_REV1-Power.SchDoc			









NOTES: UNLESS OTHERWISE SPECIFIED

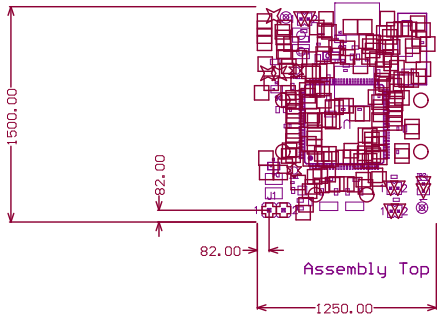
- 1. ASSEMBLY WORKMANSHIP TO MEET OR EXCEED LATEST REVISION OF IPC-A-610 CLASS 2.
- 2. THIS ASSEMBLY DRAWING SHOWS ALL COMPONENT LOCATIONS FOR ALL BOARD STUFF OPTIONS. REFER TO SPECIFIC BILL OF MATERIALS FOR COMPONENTS USED ON THAT BOARD OPTION.
- 3. PACKAGE BOARDS INDIVIDUALLY IN SHIELDED BAGS. USE ESD SENSITIVE PROCEDURES WHEN HANDLING ASSEMBLIES.

ENGINEER:	JIM PAGE	BETTER BOARDS,INC. 220 TOWNE VILLAGE DR CARY, NC 27513	
PCB DESIGNER:	SHG		
DATE:	8/11/15	TITLE:	S3_TB
FILE NAME:	S3_Tb_Rev1.PcbDoc	PART NO.:	PCB-S3_TB
		REV:	1.0

Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
⊛	2	30.00mil (0.762mm)	PTH	Round
⊙	2	40.00mil (1.016mm)	PTH	Round
⊠	3	38.98mil (0.990mm)	NPTH	Round
○	6	25.00mil (0.635mm)	NPTH	Round
▽	8	28.00mil (0.711mm)	PTH	Round
□	172	8.00mil (0.203mm)	PTH	Round
193 Total				

NOTES: UNLESS OTHERWISE SPECIFIED

- ASSEMBLY WORKMANSHIP TO MEET OR EXCEED LATEST REVISION OF IPC-A-610 CLASS 2.
- THIS ASSEMBLY DRAWING SHOWS ALL COMPONENT LOCATIONS FOR ALL BOARD STUFF OPTIONS. REFER TO SPECIFIC BILL OF MATERIALS FOR COMPONENTS USED ON THAT BOARD OPTION.
- PACKAGE BOARDS INDIVIDUALLY IN SHIELDED BAGS. USE ESD SENSITIVE PROCEDURES WHEN HANDLING ASSEMBLIES.



S3\_TB Rev 1.0 Dimension/Drill

ENGINEER:	JIM PAGEE	<b>BETTER BOARDS, INC.</b> 220 TOWNES WILKESBORO CARY, NC 27513	
DESIGNER:	SHG		
DATE:	8/11/15	TITLE:	<b>S3_TB</b>
FILE NAME:	S3_TB_Rev1_PcbDec	PART NO.:	<b>PCB-S3_TB</b>
		REV.:	<b>1.0</b>

